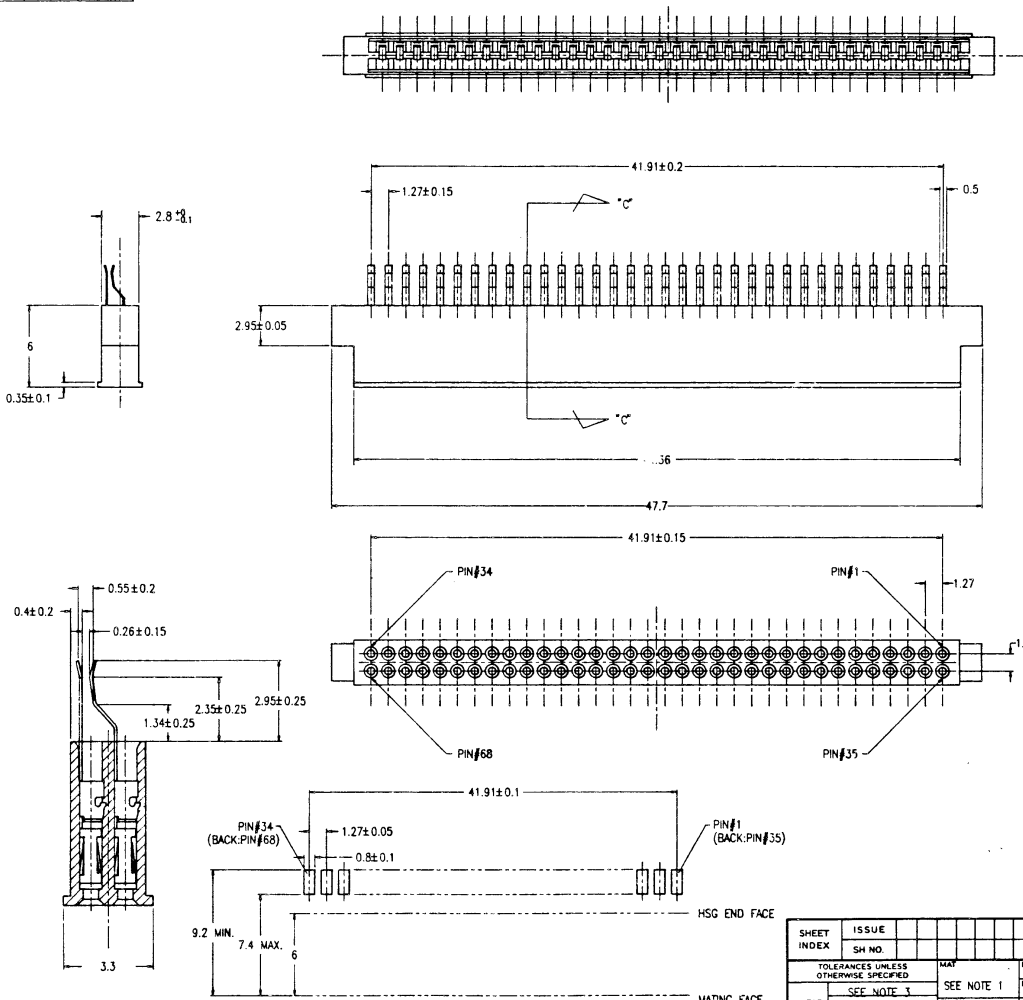


PRODUCT No.	PLUG HSG COLOR
90936-003	BLACK

REVISIONS				
REV	DESCRIPTION	ECN	BY	DATE
A	RELEASED	J2003	UK	2/7/92
B	REVISED (HSG MATERIAL)	J20210	KS	2/7/93
C	REVISED	J40024	KS	2/28/94



NOTE

- MATERIAL
CONTACT : 80Cu 0.08T
HSG. : GLASS FILLED LCP UL94V-0
FINISH
CONTACT : ALL OVER ----- Ni UNDER 0.5µm THK MIN.
SELECTIVE ----- Au PLATING 0.1µm THK MIN.
OVER Pd-Ni PLATING.
SOLDER TAIL ---- TIN LEAD 2.5µm THK. MIN.
- FOR MATING MALE CONN.(HDR./EJECTOR HDR.)
TO APPLY 68 POS. MALE CONN.(HDR./EJECTOR HDR.) BASED ON
JEIDA AND PCMCIA SPECIFICATION
- GENERAL TOLERANCE : ±0.1
- RECOMMENDED PWB THICKNESS : ±0.16 TO 0.4

DO NOT SCALE PRINT

SHEET INDEX	ISSUE	SH NO.	DATE	CUSTOMER COPY	TITLE
			2/21/98		IC CARD CONN.
TOLERANCES UNLESS OTHERWISE SPECIFIED		MAX	DR. <i>M. Nagano</i>		68POS. PL. 3 ASSY (OFFST)
LINEAR	SEE NOTE 3	FINISH	ENGR. <i>K. Sato</i>	DATE	SCALE
ANGLES	SEE NOTE 1	APPD. <i>N. Sato</i>	2/5/98	5/1	C

BERG ELECTRONICS
 STATUS: Released
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